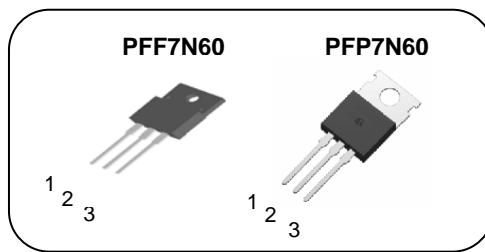


N-channel MOSFET

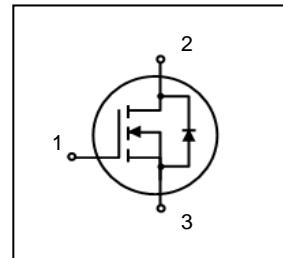
Features

- High ruggedness
- $R_{DS(ON)}$ (Max 1.2 Ω) @ $V_{GS}=10V$
- Gate Charge (Typ. 35nC)
- Improved dv/dt Capability
- 100% Avalanche Tested



1. Gate 2. Drain 3. Source

BV_{DSS} : 600V
 I_D : 7.0A
 $R_{DS(ON)}$: 1.2ohm



General Description

These N-channel enhancement mode field effect power transistor using Powergate semiconductor's advanced planar stripe, DMOS technology intended for off line switch mode power supply. Also, especially designed to minimize $R_{DS(ON)}$ and high rugged avalanche characteristics. These devices are well suited for high efficiency switching Mode power supplies and active power factor correction.

Absolute maximum ratings

Symbol	Parameter	Value		Unit
		PFP7N60	PFF7N60	
V_{DSS}	Drain to Source Voltage	600		V
I_D	Continuous Drain Current (@ $T_C=25^\circ C$)	7.0	7.0*	A
	Continuous Drain Current (@ $T_C=100^\circ C$)	4.4	4.4	A
I_{DM}	Drain current pulsed (note 1)	28	28*	A
V_{GS}	Gate to Source Voltage	± 30		V
E_{AS}	Single pulsed Avalanche Energy (note 2)	535		mJ
E_{AR}	Repetitive Avalanche Energy (note 1)	22		mJ
dv/dt	Peak diode Recovery dv/dt (note 3)	4.5		V/ns
P_D	Total power dissipation (@ $T_C=25^\circ C$)	131	49	W
	Derating Factor above 25°C	1.05	0.39	W/°C
T_{STG}, T_J	Operating Junction Temperature & Storage Temperature	-55 ~ + 150		°C
T_L	Maximum Lead Temperature for soldering purpose, 1/8 from Case for 5 seconds.	300		°C

*. Drain current limited by maximum unclipped temperature.

Thermal characteristics

Symbol	Parameter	Value		Unit
		PFP7N60	PFF7N60	
R_{thjc}	Thermal resistance, Junction to case	0.95	2.55	°C/W
R_{thcs}	Thermal resistance, Case to Sink	0.5		°C/W
R_{thja}	Thermal resistance, Junction to ambient	62.5		°C/W

PFP7N60/PFF7N60

Electrical characteristic ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Off characteristics						
BV_{DSS}	Drain to source breakdown voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600	-	-	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_{\text{D}}=250\mu\text{A}$, referenced to 25°C	-	0.68	-	$\text{V}/^\circ\text{C}$
I_{DSS}	Drain to source leakage current	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$	-	-	10	uA
		$V_{\text{DS}}=480\text{V}, T_C=125^\circ\text{C}$	-	-	100	uA
I_{GSS}	Gate to source leakage current, forward	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	100	nA
	Gate to source leakage current, reverse	$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	-100	nA
On characteristics						
$V_{\text{GS(TH)}}$	Gate threshold voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0	-	4.0	V
$R_{\text{DS(ON)}}$	Drain to source on state resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}} = 3.5\text{A}$		1.0	1.2	Ω
Dynamic characteristics						
C_{iss}	Input capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1\text{MHz}$		620	770	pF
C_{oss}	Output capacitance			73	90	
C_{rss}	Reverse transfer capacitance			20	25	
$t_{\text{d(on)}}$	Turn on delay time	$V_{\text{DS}}=300\text{V}, I_{\text{D}}=7.0\text{A}, R_G=25\Omega$		30	38	ns
t_{r}	Rising time			66	82	
$t_{\text{d(off)}}$	Turn off delay time			152	180	
t_f	Fall time			39	50	
Q_g	Total gate charge	$V_{\text{DS}}=480\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=7.0\text{A}$		35	40	nC
Q_{gs}	Gate-source charge			3.7	-	
Q_{gd}	Gate-drain charge			9.5	-	

Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_s	Continuous source current	Integral reverse p-n Junction diode in the MOSFET	-	-	7.0	A
I_{SM}	Pulsed source current		-	-	28	A
V_{SD}	Diode forward voltage drop.	$I_s=7.0\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.5	V
T_{rr}	Reverse recovery time	$I_s=7.0\text{A}, V_{\text{GS}}=0\text{V}, dI_F/dt=100\text{A/us}$	-	390	-	ns
Q_{rr}	Breakdown voltage temperature		-	1.63	-	μC

*. Notes

1. Repetitive rating : pulse width limited by junction temperature.
2. $L = 20\text{mH}, I_{\text{AS}} = 7.0\text{A}, V_{\text{DD}} = 50\text{V}, R_G=50\Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{\text{SD}} \leq 7.0\text{A}, dI/dt = 300\text{A/us}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse Width $\leq 300\text{us}$, duty cycle $\leq 2\%$
5. Essentially independent of operating temperature.

Fig. 1. On-state characteristics

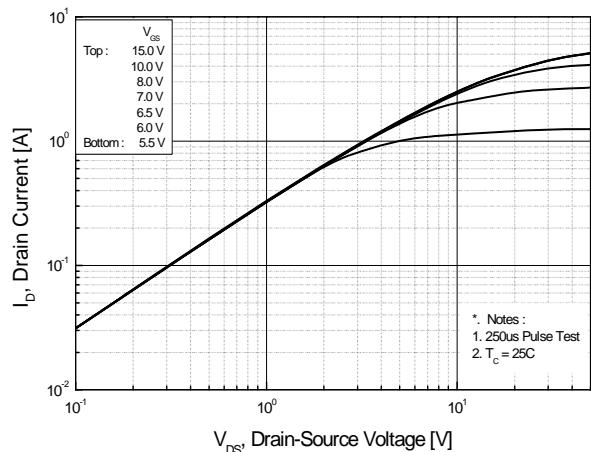


Fig. 2. Transfer characteristics

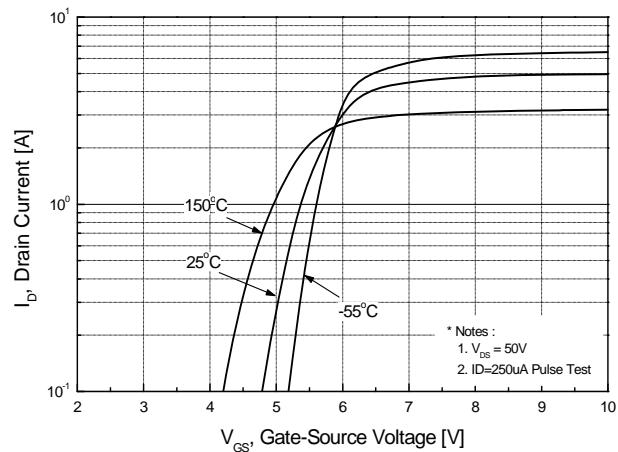


Fig. 3. On-resistance variation vs. drain current and gate voltage

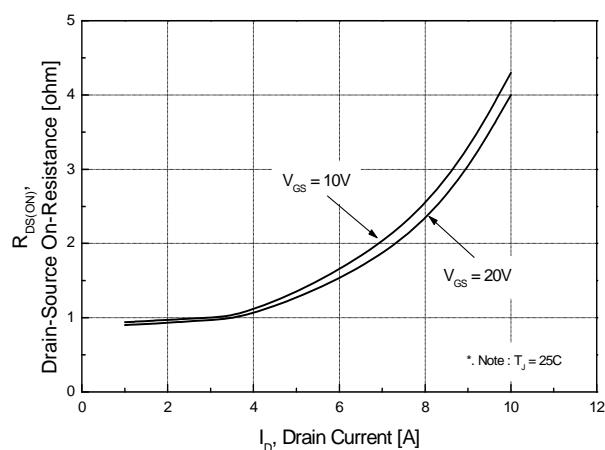


Fig. 4. On state current vs. diode forward voltage

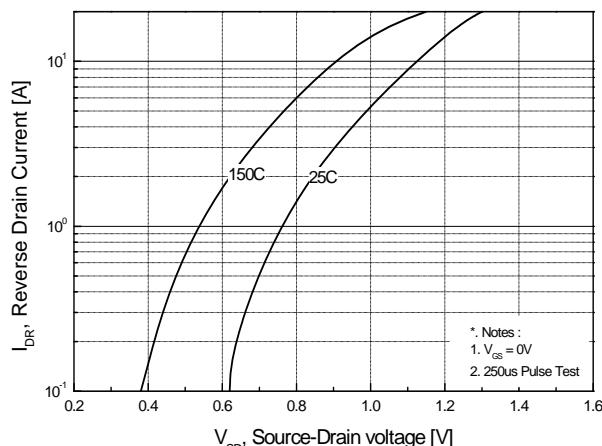


Fig. 5. Capacitance characteristics (Non-Repetitive)

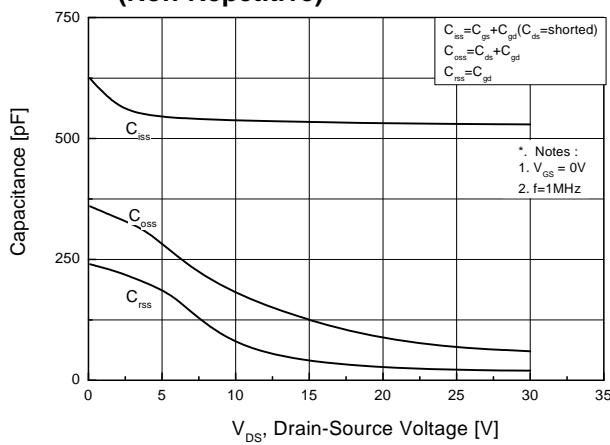


Fig. 6. Gate charge characteristics

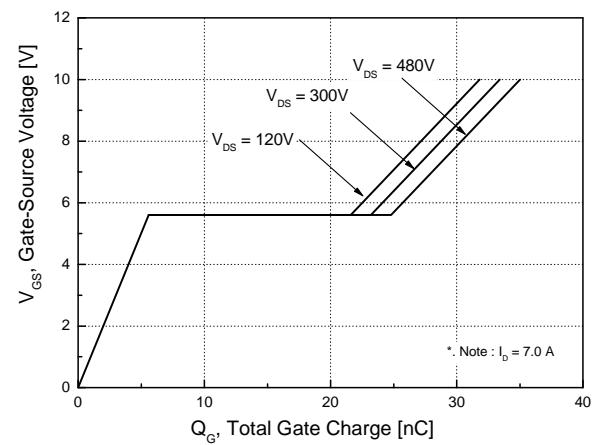


Fig 7. Breakdown Voltage Variation vs. Junction Temperature

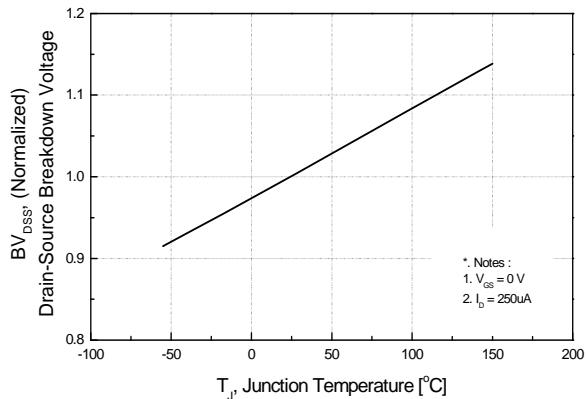


Fig. 9. Maximum drain current vs. case temperature.

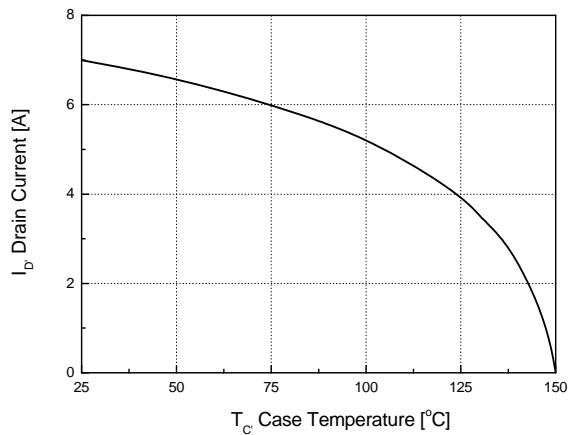


Fig. 8. On resistance variation vs. junction temperature

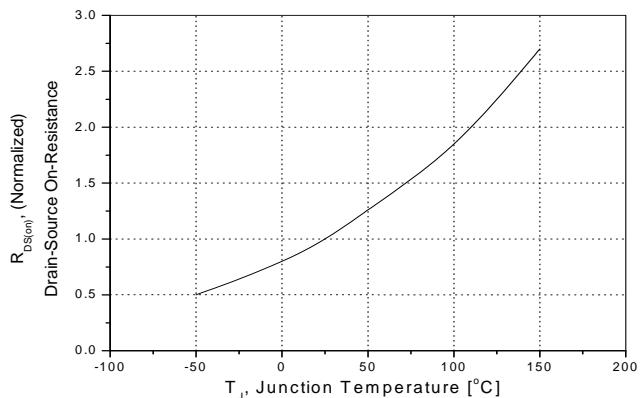


Fig. 10. Maximum safe operating area (PFP7N60)

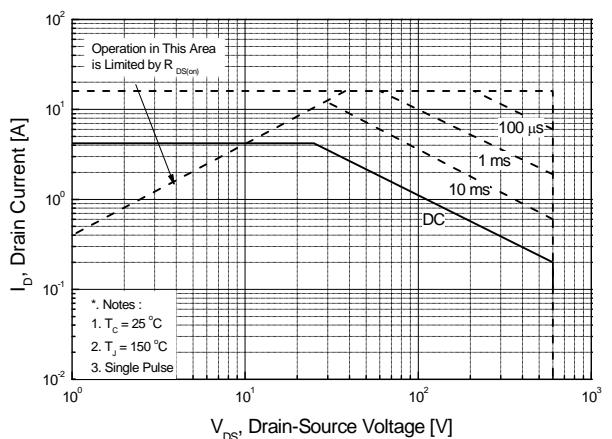


Fig. 11. Transient thermal response curve

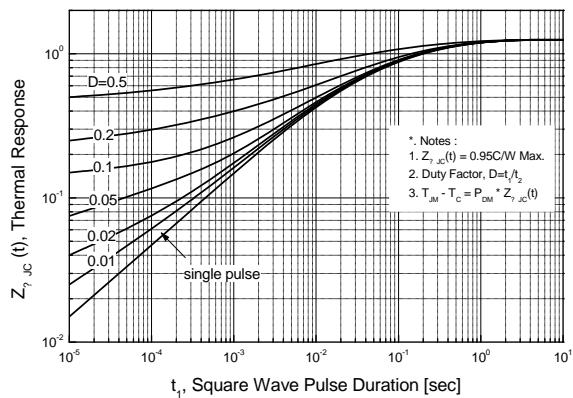


Fig. 12. Maximum safe operating area(PFF7N60)

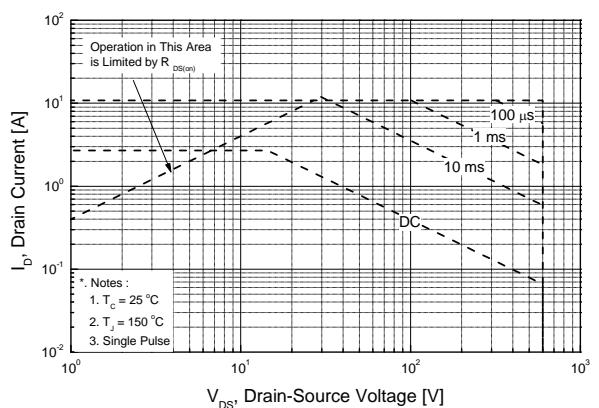


Fig. 12. Gate charge test circuit & waveform

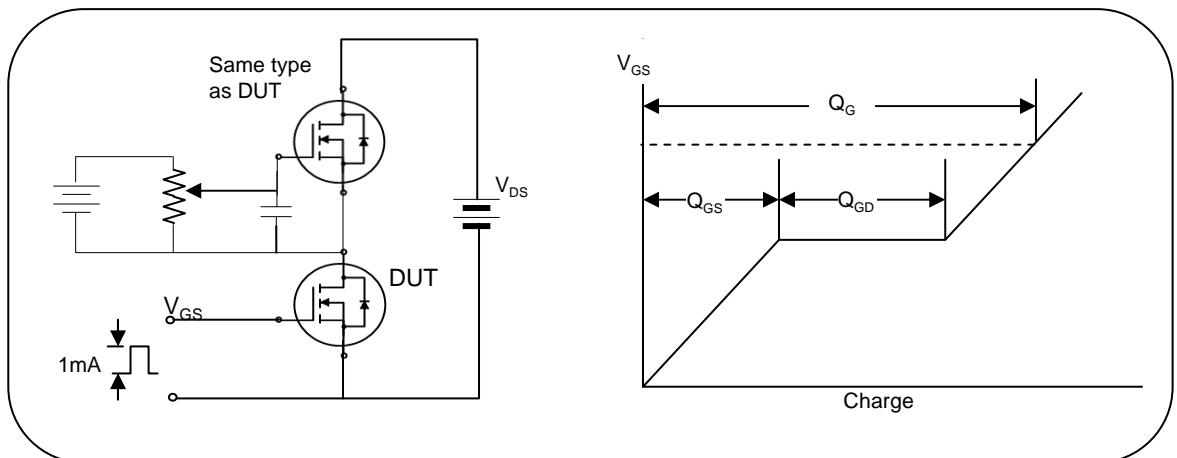


Fig. 13. Switching time test circuit & waveform

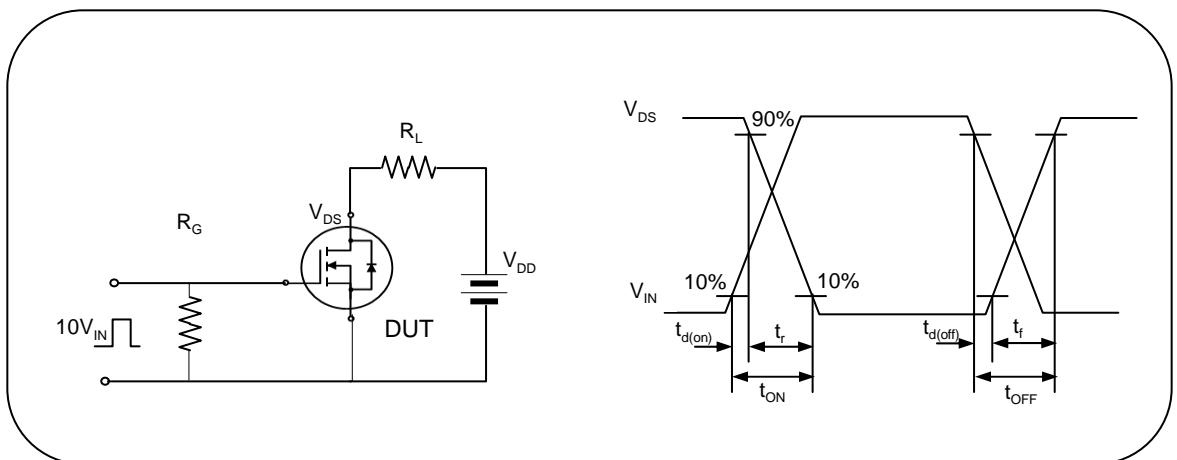


Fig. 14. Unclamped Inductive switching test circuit & waveform

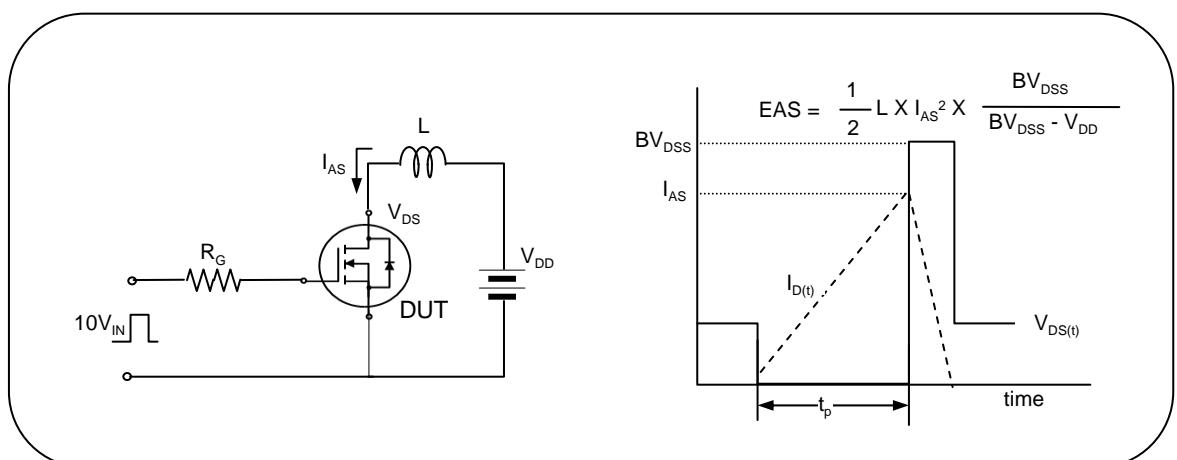
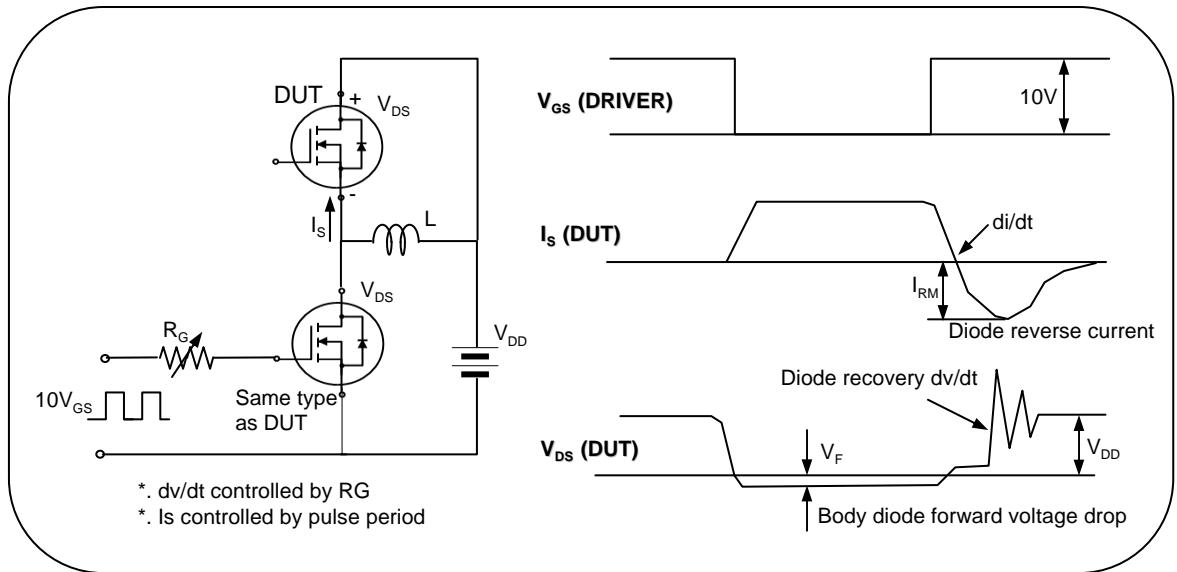
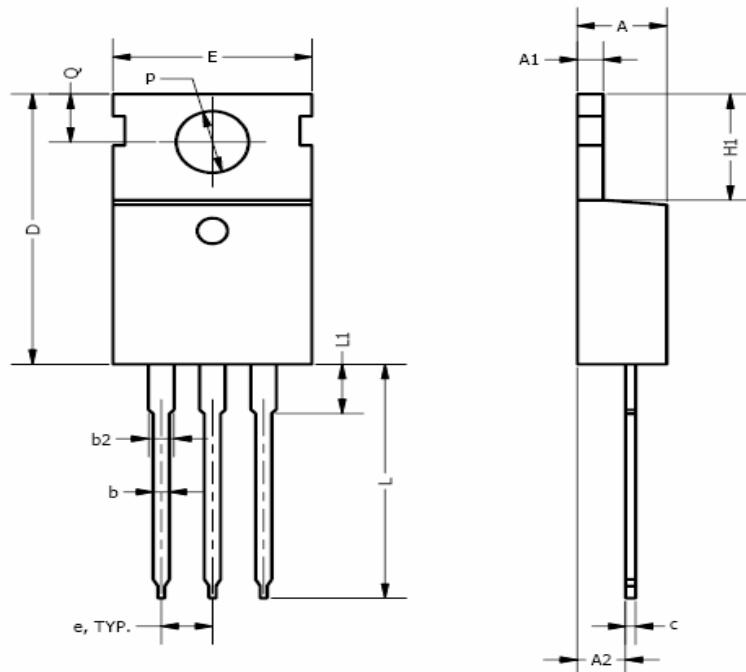


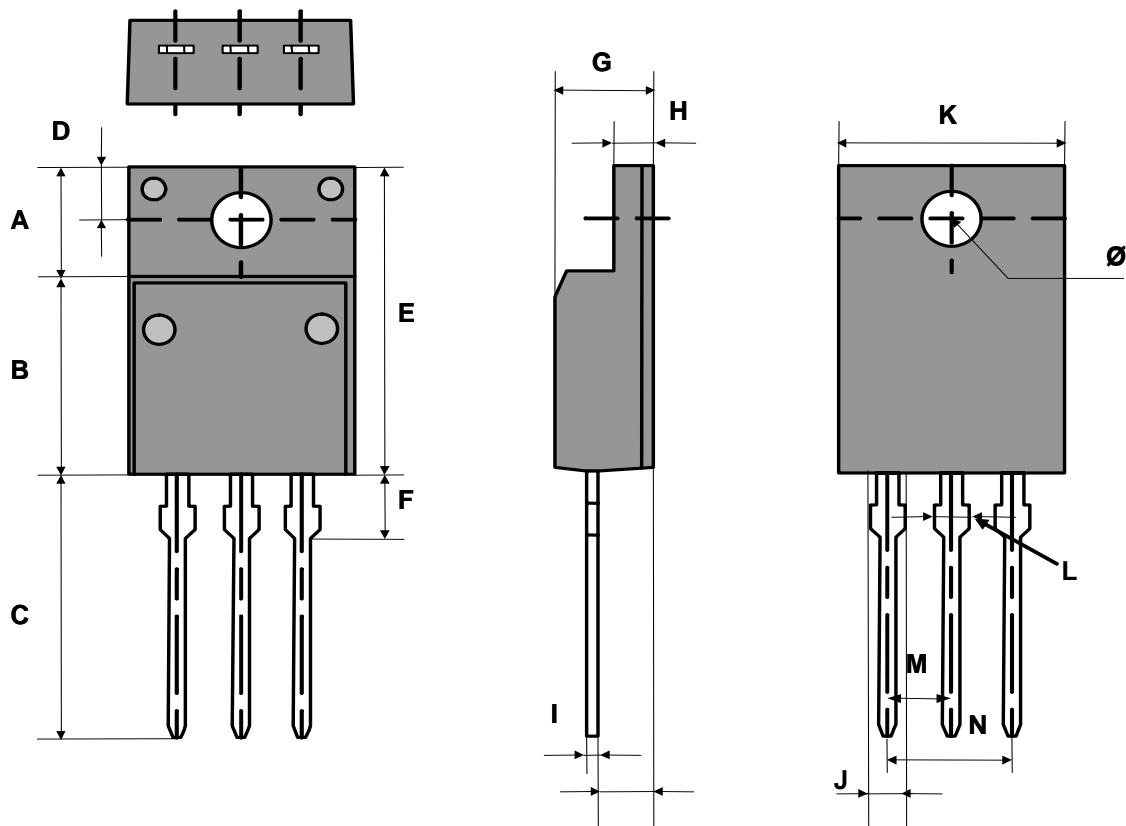
Fig. 15. Peak diode recovery dv/dt test circuit & waveform



TO-220 Package Dimension


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.14	0.19	3.56	4.83
A1	0.02	0.055	0.51	1.4
A2	0.08	0.115	2.03	2.92
b	0.015	0.04	0.38	1.02
b2	0.045	0.07	1.14	1.78
c	0.014	0.024	0.36	0.61
D	0.56	0.65	14.22	16.51
e	0.096	0.104	2.44	2.64
E	0.38	0.42	9.65	10.67
H1	0.23	0.27	5.84	6.86
L	0.5	0.58	12.7	14.73
L1	-	0.25	-	6.35
CP	0.139	0.161	3.53	4.09
Q	0.1	0.135	2.54	3.43

TO-220F Package Dimension



DIMENSION		A	B	C	D	E	F	G	H
mm	Min	6.00	7.85	12.88	3.00	15.0	3.15	4.45	3.05
	Typ.	6.05	7.90	13.08	3.02	15.2	3.25	4.50	3.10
	Max	6.10	7.95	13.28	3.04	15.4	3.35	4.55	3.15

DIMENSION		I	J	K	L	M	N	Ø	
mm	Min	0.585	1.245	9.95	1.65	2.00	4.58	2.90	
	Typ.	0.595	1.250	10.00	1.66	2.05	4.60	2.95	
	Max	0.605	1.255	10.05	1.67	2.10	4.62	3.00	